

General Description

The AOZ8533 is an 4-line device integrating EMI filtering with ESD protection for each line. It is designed to suppress unwanted EMI/RFI signals and provide electrostatic discharge (ESD) protection in portable electronic equipment. This state-of-the-art device utilizes AOS leading edge Trench Vertical Structure [TVS]²™ technology for superior clamping performance and filter attenuation over the full operating display range. The AOZ8533 has been optimized for protection of color LCD displays and CCD camera lines in cellular phones and other portable consumer electronic devices.

The AOZ8533 consists of four identical circuits comprised of TVS diodes for ESD protection, and a inductor–capacitor network for EMI/RFI filtering providing a cutoff frequency at 450MHz for high speed data lines. An inductor value of 17nH and a capacitance value of 16pF are used to achieve greater than -30dB attenuation at 1.0GHz. The TVS diodes provide effective suppression of ESD voltages in excess of \pm 30kV (air discharge) and \pm 24kV (contact discharge). This exceeds IEC 61000-4-2, level 4 ESD immunity test.

The AOZ8533 comes in an RoHS compliant, 1.2mm x 1.8mm, 0.4mm pitch DFN package and is rated over a -40°C to +85°C ambient temperature range.

Features

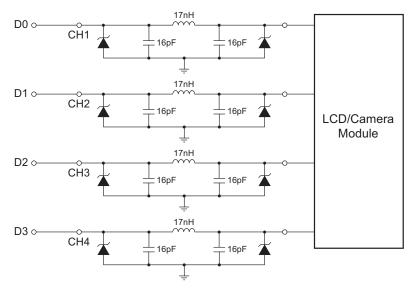
- 4 lines for EMI filtering and ESD protection:
 - Exceeds IEC 61000-4-2, level 4 (ESD) immunity test
 - $-\pm 30$ kV (air discharge) and ± 24 kV (contact discharge)
- Trench Vertical Structure [TVS]² ™ based technology used to achieve excellent ESD clamping & filter performance over the full operating display range
- Cutoff frequency: 450MHz
- Filter performance:
 - -30dB attenuation at 1.0GHz
 - -25dB attenuation from 800MHz to 5.0GHz
- Low operating voltage: 5.0V
- Capacitance stability over wide range of voltages and temperatures
- DFN package: 1.2mm x 1.8mm, 0.4mm pitch
- Pb-Free device

Applications

- EMI filtering and ESD protection for data lines
- LCD displays, camera interface, I/O interface
- Portable handheld devices, cell phones, PDA phones



Typical Application







Ordering Information

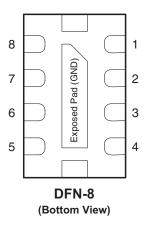
Part Number	Ambient Temperature Range	Package	Environmental
AOZ8533DI	-40°C to +85°C	DFN-8	RoHS Compliant Green Product

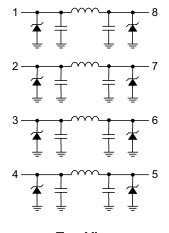


AOS Green Products use reduced levels of Halogens, and are also RoHS compliant.

Please visit www.aosmd.com/web/quality/rohs_compliant.jsp for additional information.

Pin Configuration





Top View

Pin Description

Pin Number	Pin Name	Pin Function
1, 8	CH 1	Channel 1 Connections
2, 7	CH 2	Channel 2 Connections
3, 6	CH 3	Channel 3 Connections
4, 5	CH 4	Channel 4 Connections
Exposed Pad	GND	Common Ground Connection



Absolute Maximum Ratings

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Storage Temperature (T _S)	-65°C to +150°C
ESD Rating per IEC61000-4-2, contact ⁽¹⁾	±24kV
ESD Rating per IEC61000-4-2, air ⁽¹⁾	±30kV
ESD Rating per Human Body Model ⁽²⁾	±30kV

Notes:

1. IEC 61000-4-2 discharge with C_{Discharge} = 150pF, $R_{Discharge}$ = 330 $\Omega.$

2. Human Body Discharge per MIL-STD-883, Method 3015 $C_{Discharge} = 100 pF$, $R_{Discharge} = 1.5 k\Omega$.

Electrical Characteristics

 $T_A = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{RWM}	Reverse Working Voltage	(3)			5.0	V
V _{BR}	Reverse Breakdown Volt- age	$I_{T} = 1 m A^{(4)}$	6	7	8	V
I _R	Reverse Leakage Current	V _{RWM} = 3.3V			0.1	μA
V _{CL}	Signal Clamp Voltage	$I_{LOAD} = 1A$, positive clamp ⁽⁵⁾⁽⁶⁾ $I_{LOAD} = 1A$, negative clamp ⁽⁵⁾⁽⁶⁾			10.0 -2	V
		$I_{LOAD} = 5A$, positive clamp ⁽⁵⁾⁽⁶⁾ $I_{LOAD} = 5A$, negative clamp ⁽⁵⁾⁽⁶⁾			11.0 -2.5	
		$I_{LOAD} = 12A$, positive clamp ⁽⁵⁾⁽⁶⁾ $I_{LOAD} = 12A$, negative clamp ⁽⁵⁾⁽⁶⁾			12.0 -2.75	
L _{CH}	Inductance			17		nH
C _{CH}	Capacitance	C1, C2 ⁽⁶⁾		16	18	pF
f _C	Cut-off Frequency	Measured with 50 Ω source and 50 Ω load termination at -6dB		450		MHz
	Attenuation from 800MHz to 5.0GHz	$V_R = 0V$ Measured with 50 Ω source and 50 Ω load termination		-25		dB

Notes:

3. The working peak reverse voltage, V_{RWM} , should be equal to or greater than the DC or continuous peak operating voltage level.

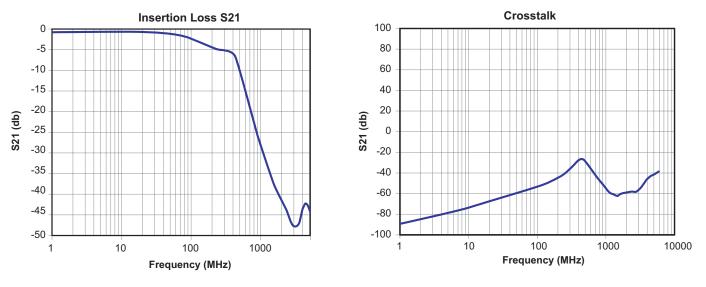
4. V_{BR} is measured at the pulse test current $\text{I}_{\text{T}}.$

5. Measurements performed using a 100ns Transmission Line Pulse (TLP) system.

6. Guaranteed by design. Not 100% tested in production.

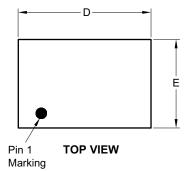


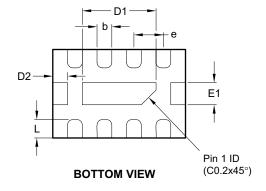
Typical Performance Characteristics

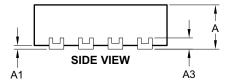




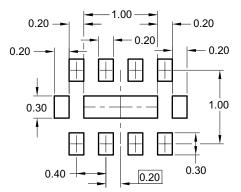
Package Dimensions, DFN 1.2 x 1.8, 8L







RECOMMENDED LAND PATTERN



Dimensions in millimeters							
Symbols	Min.	Nom.	Max.				
А	0.50	0.55	0.60				
A1	0.00	_	0.05				
A3	C).152 Re	f.				
b	0.15	0.20	0.25				
D	1.75	1.80	1.85				
D1	0.95	1.00	1.05				
D2	0.200 Ref.						
Е	1.15	1.20	1.25				
E1	0.25	0.30	0.35				
е	0.40 BSC						
L	0.20	0.25	0.30				

Dimensions in inches

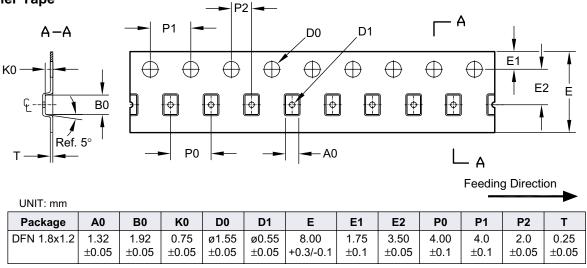
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۲.	Symbols	Min.	Nom.	Max.				
0	A	0.020	0.022	0.024				
5	A1	0.000	_	0.002				
	A3	0.006 Ref.						
5	b	0.006	0.008	0.010				
5	D	0.069	0.071	0.073				
5	D1	0.037	0.039	0.041				
	D2	0.008 Ref.						
5	E	0.045	0.047	0.049				
5	E1	0.010	0.012	0.014				
	е	0.016 BSC						
0	L	0.008	0.010	0.012				

Notes:

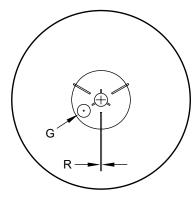
- 1. Controlling dimension is millimeter, converted inch dimensions are not necessaily exact.
- 2. Warpage shall not exceed 0.10mm.
- 3. Marking is for package orientation reference only.

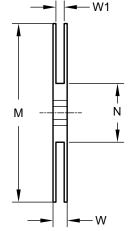
Tape and Reel Dimensions, DFN 1.2 x 1.8, 8L

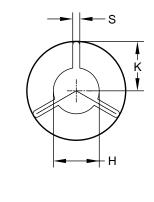
Carrier Tape



Reel



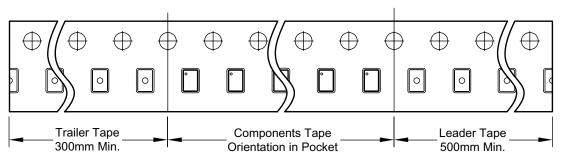




UNIT: mm

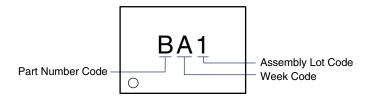
Tape Size	Reel Size	М	N	w	W1	н	S	К	G	R
8mm	ø178	ø178.0 ±1.0	ø60.0 ±1.0	11.80 ±0.5	9.0 ±0.5	ø13.0 +0.5/-0.2	2.40 ±0.10	10.25 ±0.2	ø9.8	—
		±1.0	±1.0	±0.0	±0.0	10.0/-0.2	±0.10	±0.2		

Leader / Trailer & Orientation





Package Marking



This data sheet contains preliminary data; supplementary data may be published at a later date. Alpha & Omega Semiconductor reserves the right to make changes at any time without notice.

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user. 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.